

# STAR-TOFp “HVSys” Compliance

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The STAR Time-Of-Flight Patch (TOFp) uses a custom integrated system of Cockroft-Walton bases to power the phototubes in the detector. This system is called “HVSys,” and detailed descriptions of the system and its specific implementation in STAR-TOFp can be found in Refs [1, 2, 3]. The system has been shown to meet all performance requirements.

The HVSys system was reviewed for its compliance with BNL Safety regulations on December 16, 1999 (see Ref. [2]). The only major issue that arose during this review concerns one component of this system, the so-called “System Module,” which is effectively a smart 200V power supply. This module is not U/L listed, nor has it been independantly tested by a certified laboratory such as U/L. While the BNL regulations for certification of such a module for use in STAR are evolving at present, [4] it was requested that the manufacturer of the System Module address each of the points raised in Ref. [5]. The responses provided by V. Astakhov [6], the manufacturer of HVSys, are presented here.

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# 1 Table I: Fabrication/Inspection Checklists

## 1.1 Wiring/Fuse

**Item:** wire insulation is appropriate for service (temperature, chemicals, radiation, etc.)

**Compliance?** yes

**Item:** proper size terminals are used for wire size, insulation, terminal screws, and connector pins

**Compliance?** yes

**Item:** crimps are made in a neat and workmanlike manner per manufacturer's instructions

**Compliance?** yes

**Item:** soldering is performed per manufacturer's instructions

**Compliance?** yes

**Item:** all connections are made using manufacturer's approved devices or methods

**Compliance?** yes

**Item:** soldered connections are mechanically secure prior to soldering

**Compliance?** yes

**Item:** switches disconnect all ungrounded conductors of the circuit controlled when in the off position unless no live exposed parts from this circuit are contained in the unit.

**Compliance?** yes

**Item:** panel front fuse holder screw shells are at ground potential

**Compliance?** yes

**Item:** fuse is the first item in the circuit

**Compliance?** yes

**Item:** wire ampacity up to the fuse is the same as the power cord

**Compliance?** yes

**Item:** wire ampacity after the fuse meets or exceeds the labelled ampacity of the fuse

**Compliance?** yes

**Item:** fuses are used to protect internal wiring and power leaving cabinet

is wire ampacity is smaller than feeder protection

**Compliance?** yes

## 1.2 Marking/Labeling

**Item:** main power switch is labelled "Main"

**Compliance?** Currently labelled as "Power" - will be changed to "Main"

**Item:** enclosure is labelled if supplied by multiple power sources

**Compliance?** yes

**Item:** ON/OFF positions or hazardous voltage switches are labeled.

**Compliance?** Will be so labelled.

**Item:** capacitors discharge in 3 seconds or less unless labelled as hazardous

**Compliance?** yes

**Item:** required fuse sizes are marked on the fuse holder

**Compliance?** yes

## 1.3 Enclosure Considerations

**Item:** internal temperature does not exceed rating of all wire insulation and devices

**Compliance?** yes

**Item:** cooling is appropriate for expected heat generation

**Compliance?** yes

**Item:** no external hazards are present

**Compliance?** yes

**Item:** enclosure is appropriate for service (materials, heat capacity, etc)

**Compliance?** yes

**Item:** enclosures are made of non-flammable materials

**Compliance?** yes

## 1.4 Mechanical Considerations

**Item:** separation of circuits is provided for circuits of different voltages unless all conductors are insulated for the highest voltage present.

**Compliance?** yes

**Item:** all opening minor dimensions are less than 25mm (not sockets, connectors, etc)

**Compliance?** yes

**Item:** sharp edges are filed smooth and rounded off

**Compliance?** yes

**Item:** grommets or similar protection are provided for cables entering or leaving the enclosure

**Compliance?** yes

**Item:** power cords exiting chassis are provided with strain relief so as not to exert force on terminals

**Compliance?** yes

**Item:** wiring channels are smooth, free from burrs, and provide wiring with mechanical protection from pinching, abrasion, etc

**Compliance?** yes

**Item:** cable harness is neat and installed in a workmanlike manner

**Compliance?** yes

## 1.5 Chassis

**Item:** chassis is grounded by wire and is not dependent on mounting to cabinet.

**Compliance?** yes

## 1.6 Cabinets

**Item:** No exposed live parts over 50 Volts unless there are interlocks on all cabinet doors/entrances

**Compliance?** yes

**Item:** all interconnect cords use female connectors for live voltages over 50 Volts

**Compliance?** yes

**Item:** cabinet is grounded through power cord

**Compliance?** yes

**Item:** other grounds may also be used in addition to the power ground as appropriate  
**Compliance?** yes

## References

- [1] "TOFp Technical Description," available from <http://bonner-mac8.rice.edu/~TOF/default.html>.
- [2] "TOFp Safety Review Talk," available from <http://bonner-mac8.rice.edu/~TOF/default.html>.
- [3] "HVSys Information," available from <http://bonner-mac8.rice.edu/~TOF/default.html>.
- [4] J. Curtiss, private communication.
- [5] "Engineering Standard," ESB Technical Committee, LLNL, obtained via FAX from J. Curtiss, Mar. 3, 2000.
- [6] V. Astakhov (JINR-Dubna), [astakhov@sunhe.jinr.ru](mailto:astakhov@sunhe.jinr.ru).